

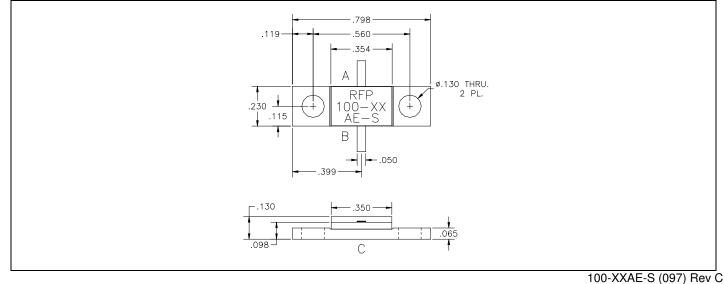
RF Power



Features:

- DC –See Chart
- 100 Watts
- BeO Ceramic
- Non-Nichrome Resistive
 Element
- Low VSWR
- Welded Silver Leads
- 100% Tested

Outline Drawing







Available on Tape and Reel For Pick and Place Manufacturing. USA/Canada: Toll Free: Europe: (315) 432-8909 (800) 544-2414 +44 2392-232392

RoHs Compliant

Model 100-XXAE-S

ATTENUATOR FULL FLANGE 100 Watts

General Specifications

Resistive Element	Thick film
Substrate	Beryllium oxide ceramic
Cover	Alumina Ceramic
Mounting Flange	Copper, Nickel plated per QQ-N- 290
Lead(s):	99.99% pure silver (.006" thick)

Electrical Specifications

Attenuation Range:	1, 2, 3, 4, 5, 6, 9, 10, 20, 22 or 30 dB
Frequency Range;	DC – See Chart
Power:	100 Watts
VSWR	See Chart
	ess otherwise specified. Designed to meet of IL-E-5400. Operating temperature is -55°C to

exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 150°C (see chart for derating temperatures). All dimensions in inches.

Specifications subject to change with out notice.



RF Power

Typical Performance:

SPECIFICATION CHART							
ATTENUATION	FREQ.	VSWR	VALUE (A-B)	VALUE (A-C)	VALUE (B-C)	TOL.	RFP P/N
1dB ±0.4	DC-1GHZ.	1.45:1	5.8 <u>n</u>	435.9 <u>∩</u>	435.9 <u>n</u>	±4%	RFP-100-1AE-S
2dB ±0.4	DC-1GHZ.	1.40:1	11.4 <u>Ω</u>	220.7 <u>n</u>	220.7 <u>n</u>	±4%	RFP-100-2AE-S
3dB ±0.4	DC-1GHZ.	1.35:1	17.0 <u>∩</u>	150.5 _A	150.5 _A	±4%	RFP-100-3AE-S
4dB ±0.3	DC-1GHZ.	1.30:1	22.6 <i>∩</i>	116.3 <u>∩</u>	116.3 <u>n</u>	±4%	RFP-100-4AE-S
5dB ±0.3	DC-1GHZ.	1.25:1	28.0 <i>∩</i>	96.0 N	96.0 A	±4%	RFP-100-5AE-S
6dB ±0.3	DC-1GHZ.	1.20:1	32.2∩	83.6 <u>n</u>	83.6 <u>n</u>	±4%	RFP-100-6AE-S
9dB ±0.3	DC-1GHZ.	1.20:1	47.6Ω	64.4 <u>∩</u>	64.4 <i>∩</i>	±4%	RFP-100-9AE-S
10dB ±1.2	DC-2GHZ.	1.25:1	52.0A	61.0 <u>n</u>	61.0 <u>n</u>	±4%	RFP-100-10AE-S
20dB ±0.5	DC-2.5GHZ.	1.20:1	81.7Ω	50.9 n	50.9 A	±4%	RFP-100-20AE-S
22dB ±0.5	DC-1GHZ.	1.20:1	85.3 <u>n</u>	50.6 <u>n</u>	50.6 A	±4%	RFP-100-22AE-S
30dB ±2.0	DC-2GHZ.	1.20:1	92.5 <u>n</u>	49.6 <u>∩</u>	49.6 <u>೧</u>	±4%	RFP-100-30AE-S

Power De-rating:

.025 MIN. (2 PLACES) BOARD LOWER BOARD LOWER BOARD EVEN WITH LEAD. BOARD HIGHER THAN LEAD. THAN LEAD. THAN LEAD. POWER DERATING SUGGESTED STRESS RELIEF METHODS NOT RECOMMENDED APPLICATION SCALE: NONE SCALE: NONE 100 POWER SUGGESTED MOUNTING PROCEDURES: 75 MAKE SURE THAT THE DEVICES ARE MOUNTED ON RATED 1. FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER. 50 DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED. 2. 25 Ч COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH 3 8 0 QUALITY SILICONE GREASE (.001" MAX. THICKNESS). POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. 4. 25 50 75 100 125 150 P.C.B. SOLDER INTERFACE TEMPERATURE-C (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID). SOLDER LEADS IN PLACE USING APPROPROATE SOLDER WITH A CONTROLLED TEMPERATURE IRON. 5. ** FOR MORE DETAILS CONTACT FACTORY ** 100-XXAE-S (097) Rev C

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Mounting Footprint and Procedure: